

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	electrode\$1 with (columnar pillar project\$3) with (step near top near surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:36
L2	28	electrode\$1 and (columnar pillar project\$3) and (step near top near surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:31
L3	12	(columnar pillar project\$3) with (step near top near surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:37
L4	182	(columnar pillar project\$3) and (step near top near surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:37
L5	1	4 and (light near (lid cap cover))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:48
L6	99	4 and (lid cap cover)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:38
L7	1	6 and (seal\$3 near resin)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:39
L8	33	6 and resin	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:42

L9	66	6 not 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:42
L10	0	(light near (lid cap cover)) with ((wir\$3 trace metal) near connect\$3) with electrode\$1 with terminal\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:54
L11	1	(light near (lid cap cover)) with ((wir\$3 trace metal) near connect\$3) with electrode\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:50
L12	24	(light near (lid cap cover)) and ((wir\$3 trace metal) near connect\$3) with electrode\$1 with terminal\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:53
L13	4115	((wir\$3 trace metal) near connect\$3) with electrode\$1 with terminal\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:54
L14	1379	13 and (LED light)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:54
L15	26181	(light near2 (lid cap cover))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:55
L16	37	15 and 13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 18:58
L17	32	(protect\$3 near (layer\$1 film\$1)) near2 (open\$3 recess) near2 surface near2 (chip die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 19:10

L18	14	(protect\$3 near (layer\$1 film\$1)) near2 (open\$3 recess) with surface near2 (chip die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/02 19:10
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